DEUTSCH

TE Internal #: ZPF000000000099565 Socket, Contact Insert, 13 A, Wire-to-Board, Sealable, Power, Signal & High Speed Data

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Connectors > Rectangular Connectors > Rectangular Contact Inserts



Rectangular Connector Insert Type: Contact Insert

Contact Type: Socket

Connector System: Wire-to-Board

Number of Positions: 11

Sealable: Yes

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board	
Rectangular Connector Insert Type	Contact Insert	
Connector System	Wire-to-Board	
Sealable	Yes	
Configuration Features		
Number of Positions	11	
Body Features		

Primary Product Material	Composite	
Contact Footures		

Contact Features

Contact Type	Socket
Contact Current Rating (Max)	13 A

Mechanical Attachment

Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.62 mm, 4.4 mm[.103 in][.173 in]

Usage Conditions



Operation/Application

Circuit Application	Power, Signal & High Speed Data	
Packaging Features		
Packaging Method	Package	
Packaging Quantity	1	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量超出标准 Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JAN 2025 (247) SVHC > Threshold: Pb (1.2% in alloy) Dodecamethylcyclohexasiloxane (D6) (1% in component) Decamethylcyclopentasiloxane (D5) (1% in component) Octamethylcyclotetrasiloxane (D4) (1% in component) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts



Customers Also Bought





















Documents

Product Drawings 732-8256-99

English

CAD Files
3D PDF

3D



Customer View Model

ENG_CVM_CVM_ZPF000000000099565_1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_ZPF000000000099565_1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_ZPF000000000099565_1.3d_stp.zip

English

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Datasheets & Catalog Pages

DEUTSCH DMC-M Series Multicavity EN4165 Connectors

English

DMC-M Series Single Module EN4165

English